

Silicon Carbide sSiC

CHEMICAL COMPOSITION		95%wt 0.5%wt <5%wt 0.04 0.01 0.05	* by difference
PHYSICAL PROPERTIES	Mean grain size Sintered density Bending strength at 20° C Hardness H _{v0.5}	- 3.1 g/cm ³ 400 MPa 2200 Hv	
THERMAL PROPERTIES	Thermal conductivity at 20°C	100 W.m ⁻¹ .k ⁻¹	
ELECTRICAL PROPERTIES	Dielectric constant at 25°C-1MHz tan δ DC Volume resistivity at 25°C Dielectric strength at 3mm	- 4.10 ⁻³ (1GHz) 5.10 ⁷ Ω.cm 0 kV/mm ⁻¹	
MICROSTRUCTURE	Image: Display	$P_{n} = P_{n} + P_{n$	
KEY FEATURES	Light weight, good wear resistance, high ha	ardness	

TYPICAL APPLICATIONS Rotor and ball valves components, nozzles, cutting blades, special pump plungers, turbine components, sealing elements, bearings elements, wear plates, heat exchangers.